

RECOR.

102139758

NT APPLICATION

NAME OF CONVEYING PARTY

Tetsuya MIYABE

NAME OF RECEIVING PARTY

KAYABA INDUSTRY CO., LTD.

ADDRESS OF RECEIVING PARTY

World Trade Center Bldg. 4-1, Hamamatsu-cho, 2-chome

Tokyo 105-6190, Japan

NATURE OF CONVEYANCE

Assignment of U.S. Patent application

CONVEYANCE EXECUTION DATE

June 19, 2002

6-24-02

PATENT APPLICATION NO.

To be assigned

PATENT APPLICATION FILING DATE

June 24, 2002

APPLICATION FILED TOGETHER

WITH THIS DOCUMENT

YES

APPLICATION EXECUTION DATE

June 14, 2002

CORRESPONDENCE

ADDRESS

DENCE :

RABIN & BERDO, P.C.

1101 14th Street, N.W., Suite 500

Washington, DC 20005 (Customer No: 23995)

ATTORNEY REFERENCE

GOT 156

TOTAL NUMBER OF PATENTS AND APPLICATIONS INVOLVED

One

10176619

TOTAL FEE PAID

\$40.00

METHOD OF PAYMENT

[X]

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Authorized to be charged to

deposit account

Enclosed

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Robert H. Berdo, Jr. (Reg. No. 38,075)

June 24, 2002

Date

Total number of pages including cover sheet, attachments and document: 2.

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PATENT REEL: 013028 FRAME: 0085 Received: 6/21/02 2:54AM; ->Rabin & Berdo PC; #461; Page 3

2002年 6月21日 15時40分 後藤特許事務所

NO. 6346 P. 3

00-1	Attorney Reference				
AS	SIGNMENT OF APPI	LICATION FOR UNIT	ED STATES LETTER	S PATENT	
WHEREAS	Tetsuya	MIYABE			
hereinafter referred to c	ollectively as the assi	gnor, has invented a	ertain improvement n	elating to	-
FRONT FOR	K			,	
[] the inventor's declare application to be filed in	ation for said applicati the United States Pa	ion being executed co tent and Trademark C	ncurrently with the ex office;	ecution of this instrument; sa	id
being hereby given to m	ny attorneys, Steven I GNE P.C. 1101 14	M. Rabin, Thomas M. The Street N.W. Suit	Champagne, Robert	on, authoriza H. Berdo, Jr , and David S. D.C. 20005, to insert here aid application when known;	Lee
[] said application havii Serial No	the United States	of America being day	signated:		
				, hereinafter	
referred to as the assign	iee, is desirous of acc d continuations therec	quiring the entire right, of, and in and to said i	, title and interest in ar mprovement and any	, hereinafter nd to said application, include and all patents which may be	ng •
consideration paid by a hereby assigns, sells an right, title and interest in said improvement and a prolongations thereof; the said application, included patents which may be grights, powers, privilege terms of any and all suct the use and benefit of sa as said assignor might of the said a	said assignee to said as and to said application and to said application and all patents when aid assignee, and said application and all divition and advantages in the patents when grantaid assignee, and said assignee, and said accould have held and	d assignor, the recei signee, and said assigner, and said assigner, including any and nich may be granted to assignee's successions and continuatio ding any and all renerany way arising fronted, including any and assignee's successed enjoyed the same, if	pt of which is hereby gnee's successors and all divisions and cont herefor, including any sors and assigns, to ns thereof, and the sawals, reissues and propertaining their all renewals, reissue and assigns, in as this assignment had		nor sive if to and sjoy I all the or for ner
AND said assignor l assigns, any and all act reissues and prolongation	relating to the obtain	form, upon the reques ning or to the asserting	it of said assignee, or g of said patents, inclu	r said assignee's successors iding any and all renewals,	Or
AND said assignor a application, and on any successors and assigns	and all divisions and o	continuations thereof,	ents and Trademarks to said assignee, and	to issue Letters Patent on s said assignee's	aid
EXEC	UTED, this _ <i>19x</i> day	of June	, 20 <u></u> 04		
WITNESSES:	<u>.</u> •	ASSIGNOR			
Signature:		Signature:	Desseya	Migabe	•
Name:			Tetsuya		
Address:					
Signature:		Signature:			
Name:		Name:			
Address:					

PATENT REEL: 013028 FRAME: 0086